

1.5A Dual Open-Drain MOSFET Drivers

Features

- Independently Programmable Rise and Fall Times
- Low Output Impedance: 7Ω Typical
- High Speed t_R , t_F : <30 ns with 1000 pF Load
- Short Delay Times: <30 ns
- Wide Operating Range: 4.5V to 18V
- Latch-Up Protected: withstands > 500 mA Reverse Current (Either Polarity)
- Input Withstands Negative Swings up to -5V

Applications

- Motor Controls
- Driving Bipolar Transistors
- Driver for Non-Overlapping Totem Poles
- Reach-Up/Reach-Down Driver

TABLE 1: DEVICE SELECTION TABLE

| Part Number | Package | Temp. Range |
|-------------|-------------|----------------|
| TC4404COA | 8-Lead SOIC | 0°C to +70°C |
| TC4404CPA | 8-Lead PDIP | 0°C to +70°C |
| TC4404EOA | 8-Lead SOIC | -40°C to +85°C |
| TC4404EPA | 8-Lead PDIP | -40°C to +85°C |
| TC4405COA | 8-Lead SOIC | 0°C to +70°C |
| TC4405CPA | 8-Lead PDIP | 0°C to +70°C |
| TC4405EOA | 8-Lead SOIC | -40°C to +85°C |
| TC4405EPA | 8-Lead PDIP | -40°C to +85°C |

General Description

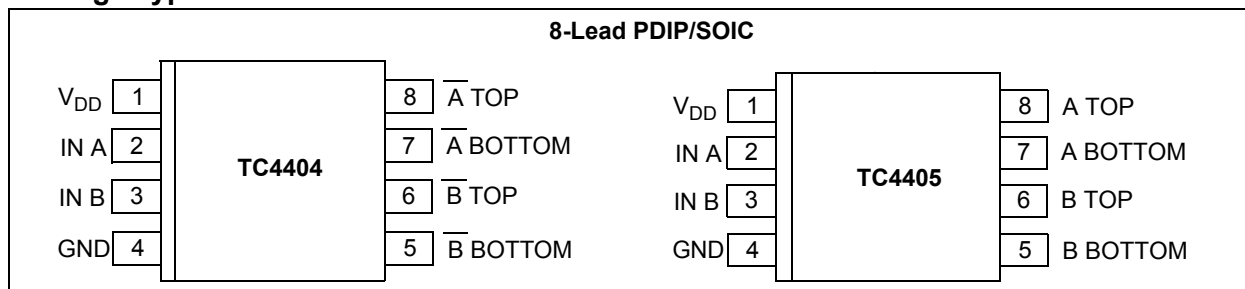
The TC4404/TC4405 are CMOS buffer-drivers constructed with complementary MOS outputs, where the drains of the totem-pole output have been left separated so that individual connections can be made to the pull-up and pull-down sections of the output. This allows the insertion of drain-current-limiting resistors in the pull-up and/or pull-down sections, allowing the user to define the rates of rise and fall for a capacitive load. It also enables a reduced output swing, if driving a resistive load, or limiting base current when driving a bipolar transistor. Minimum rise and fall times, with no resistors, will be less than 30 ns for a 1000 pF load.

For driving MOSFETs in motor-control applications, where slow-ON/fast-OFF operation is desired, these devices are superior to the previously used technique of adding a diode-resistor combination between the driver output and the MOSFET, because they allow accurate control of turn-on, while maintaining fast turn-off and maximum noise immunity for an OFF device.

When used to drive bipolar transistors, these drivers maintain the high speeds common to other Microchip drivers. They allow insertion of a base current-limiting resistor, while providing a separate half-output for fast turn-off. By proper positioning of the resistor, either NPN or PNP transistors can be driven.

For driving many loads in low-power regimes, these drivers require significantly less power at higher frequencies and can be helpful in meeting low-power budgets as they eliminate shoot-through currents in the output stage.

Package Type

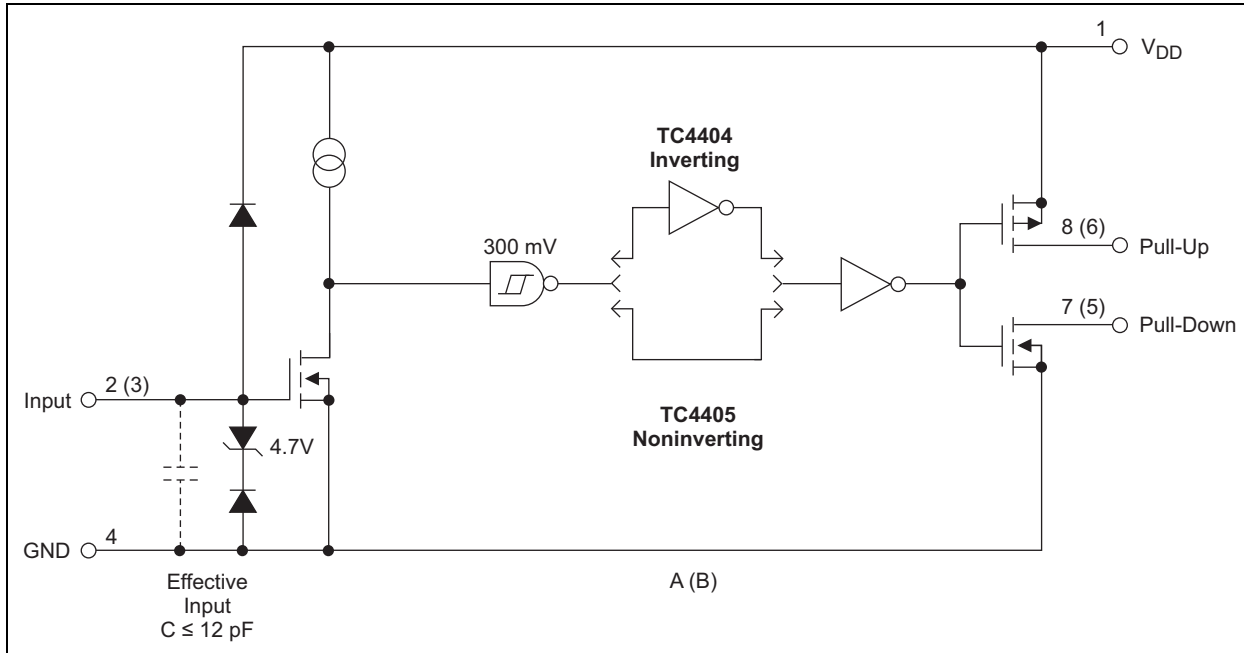


TC4404/TC4405

Because neither drain in an output is dependent on the other, these devices can also be used as open-drain buffer/drivers where both drains are available in one device, thus minimizing chip count. Unused open drains should be returned to the supply rail so that their device sources are connected (pull-downs to ground, pull-ups to V_{DD}), to prevent static damage. In addition, in situations where timing resistors or other means of limiting crossover currents are used, like drains from drivers A and B, they may be paralleled for greater current carrying capacity.

These devices are built to operate in the most demanding electrical environments. They will not latch-up under any conditions within their power and voltage ratings; they are not subject to damage when up to 5V of noise spiking of either polarity occurs on their ground pin; and they can accept, without damage or logic upset, up to 0.5A of reverse current (of either polarity) being forced back into their outputs. All terminals are fully protected against up to 2 kV (HBM) of electrostatic discharge.

Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

| | |
|--|---|
| Supply Voltage | +22V |
| Power Dissipation ($T_A \leq +70^\circ\text{C}$) | |
| PDIP | 730 mW |
| SOIC | 470 mW |
| Operating Temperature Range | |
| C Version | 0°C to $+70^\circ\text{C}$ |
| E Version | -40°C to $+85^\circ\text{C}$ |
| Storage Temperature Range | -65°C to $+150^\circ\text{C}$ |

† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

DC CHARACTERISTICS

Electrical Characteristics: Unless otherwise specified, all limits apply for typical values at ambient temperature $T_A = +25^\circ\text{C}$, with $4.5\text{V} \leq V_{DD} \leq 18\text{V}$.

| Parameter | Sym. | Min. | Typ. | Max. | Units | Conditions |
|--|----------|------------------|---------|------------|---------------|--|
| Input | | | | | | |
| Logic 1, High Input Voltage | V_{IH} | 2.4 | — | — | V | |
| Logic 0, Low Input Voltage | V_{IL} | — | — | 0.8 | V | |
| Input Current | I_{IN} | -1 | — | 1 | μA | $0\text{V} \leq V_{IN} \leq V_{DD}$ |
| Output | | | | | | |
| High Output Voltage | V_{OH} | $V_{DD} - 0.025$ | — | — | V | |
| Low Output Voltage | V_{OL} | — | — | 0.025 | V | |
| Output Resistance | R_O | — | 7 | 10 | Ω | $I_{OUT} = 10\text{ mA}$, $V_{DD} = 18\text{V}$; any drain |
| Peak Output Current (Any Drain) | I_{PK} | — | 1.5 | — | A | Duty cycle $\leq 2\%$, $t \leq 300\text{ }\mu\text{sec}$ |
| Continuous Output Current (Any Drain) | I_{DC} | — | — | 100 | mA | |
| Latch-Up Protection (Any Drain) Withstand Reverse Current | I_R | — | > 500 | — | mA | Duty cycle $\leq 2\%$, $t \leq 300\text{ }\mu\text{sec}$ |
| Switching Time (Note 1) | | | | | | |
| Rise Time | t_R | — | 25 | 30 | ns | Figure 4-1, $C_L = 1000\text{ pF}$ |
| Fall Time | t_F | — | 25 | 30 | ns | Figure 4-1, $C_L = 1000\text{ pF}$ |
| Delay Time | t_{D1} | — | 15 | 30 | ns | Figure 4-1, $C_L = 1000\text{ pF}$ |
| Delay Time | t_{D2} | — | 32 | 50 | ns | Figure 4-1, $C_L = 1000\text{ pF}$ |
| Power Supply | | | | | | |
| Power Supply Current | I_S | — | — | 4.5 0.4 | mA | $V_{IN} = 3\text{V}$ (both inputs) $V_{IN} = 0\text{V}$ (both inputs) |

Note 1: Switching times ensured by design.

TC4404/TC4405

DC CHARACTERISTICS (OVER OPERATING TEMPERATURE RANGE)

| Electrical Characteristics: Unless otherwise indicated, operating temperature range with $4.5V \leq V_{DD} \leq 18V$. | | | | | | |
|---|----------|------------------|-------|----------|----------|--|
| Parameter | Sym. | Min. | Typ. | Max. | Units | Conditions |
| Logic 1, High Input Voltage | V_{IH} | 2.4 | — | — | V | |
| Logic 0, Low Input Voltage | V_{IL} | — | — | 0.8 | V | |
| Input Current | I_{IN} | -10 | — | 10 | μA | $0V \leq V_{IN} \leq V_{DD}$ |
| Output | | | | | | |
| High Output Voltage | V_{OH} | $V_{DD} - 0.025$ | — | — | V | |
| Low Output Voltage | V_{OL} | — | — | 0.025 | V | |
| Output Resistance | R_O | — | 9 | 12 | Ω | $I_{OUT} = 10 \text{ mA}$, $V_{DD} = 18V$; any drain |
| Peak Output Current (Any Drain) | I_{PK} | — | 1.5 | — | A | Duty cycle $\leq 2\%$, $t \leq 300 \mu\text{sec}$ |
| Continuous Output Current (Any Drain) | I_{DC} | — | — | 100 | mA | |
| Latch-Up Protection (Any Drain) Withstand Reverse Current | I_R | — | > 500 | — | mA | Duty cycle $\leq 2\%$, $t \leq 300 \mu\text{sec}$ |
| Switching Time (Note 1) | | | | | | |
| Rise Time | t_R | — | — | 40 | ns | Figure 4-1, $C_L = 1000 \text{ pF}$ |
| Fall Time | t_F | — | — | 40 | ns | Figure 4-1, $C_L = 1000 \text{ pF}$ |
| Delay Time | t_{D1} | — | — | 40 | ns | Figure 4-1, $C_L = 1000 \text{ pF}$ |
| Delay Time | t_{D2} | — | — | 60 | ns | Figure 4-1, $C_L = 1000 \text{ pF}$ |
| Power Supply | | | | | | |
| Power Supply Current | I_S | — | — | 8 0.6 | mA | $V_{IN} = 3V$ (both inputs) $V_{IN} = 0V$ (both inputs) |

Note 1: Switching times ensured by design.

TEMPERATURE SPECIFICATIONS

| Electrical Specifications: Unless otherwise noted, all parameters apply with $4.5V \leq V_{DD} \leq 18V$. | | | | | | |
|---|---------------|------|------|------|----------------------|------------|
| Parameters | Sym. | Min. | Typ. | Max. | Units | Conditions |
| Temperature Ranges | | | | | | |
| Operating Temperature Range, C Version | T_A | 0 | — | +70 | $^{\circ}\text{C}$ | |
| Operating Temperature Range, E Version | T_A | -40 | — | +85 | $^{\circ}\text{C}$ | |
| Storage Temperature Range | T_A | -65 | — | +150 | $^{\circ}\text{C}$ | |
| Package Thermal Resistances | | | | | | |
| Thermal Resistance, 8-Lead PDIP | θ_{JA} | — | +94 | — | $^{\circ}\text{C/W}$ | |
| Thermal Resistance, 8-Lead PDIP | θ_{JC} | — | +45 | — | $^{\circ}\text{C/W}$ | |
| Thermal Resistance, 8-Lead SOIC | θ_{JA} | — | +163 | — | $^{\circ}\text{C/W}$ | |
| Thermal Resistance, 8-Lead SOIC | θ_{JC} | — | +42 | — | $^{\circ}\text{C/W}$ | |

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

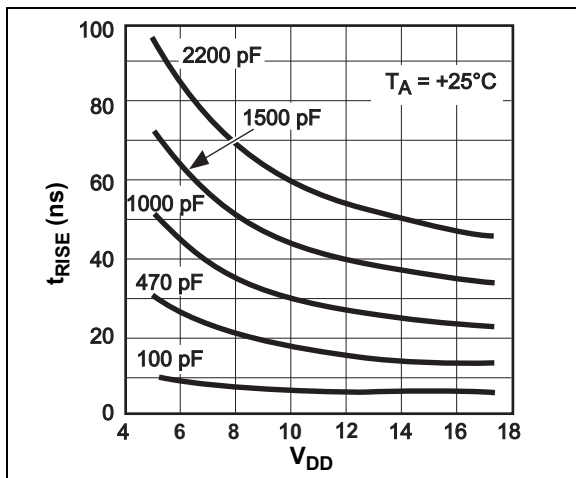


FIGURE 2-1: Rise Time vs. Supply Voltage.

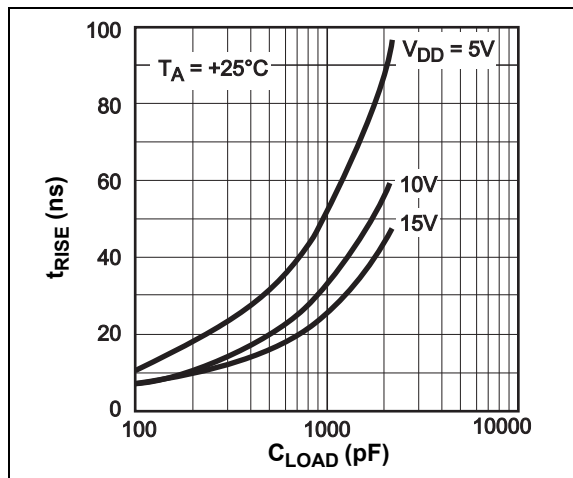


FIGURE 2-3: Rise Time vs. Capacitive Load.

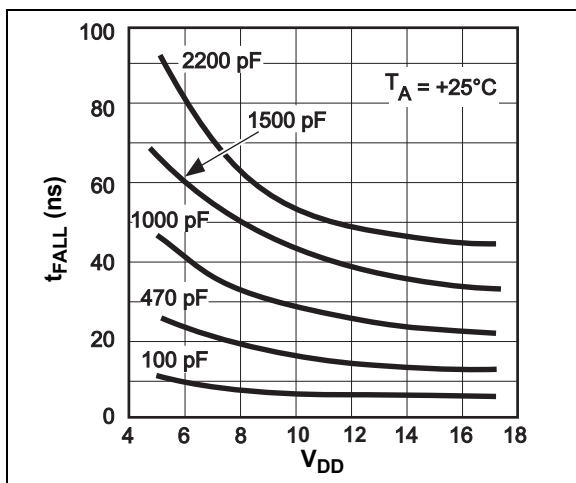


FIGURE 2-2: Fall Time vs. Supply Voltage.

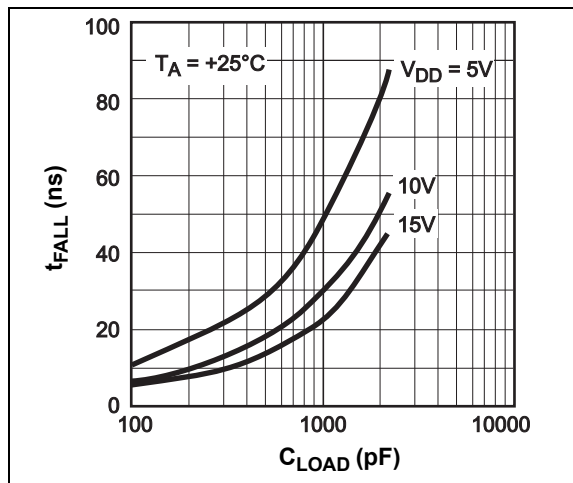


FIGURE 2-4: Fall Time vs. Capacitive Load.

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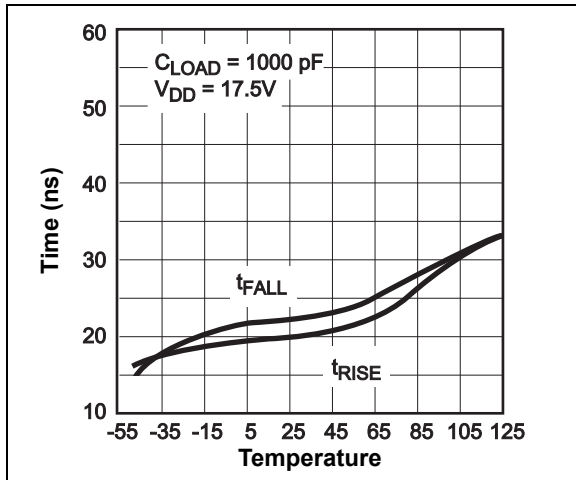


FIGURE 2-5: Rise and Fall Times vs. Temperature.

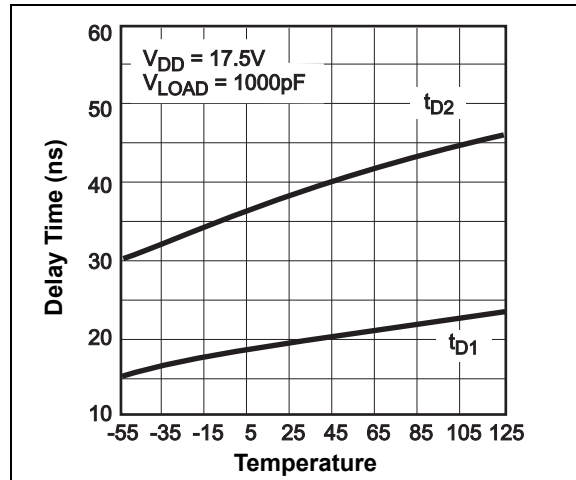


FIGURE 2-8: Propagation Delay Time vs. Temperature.

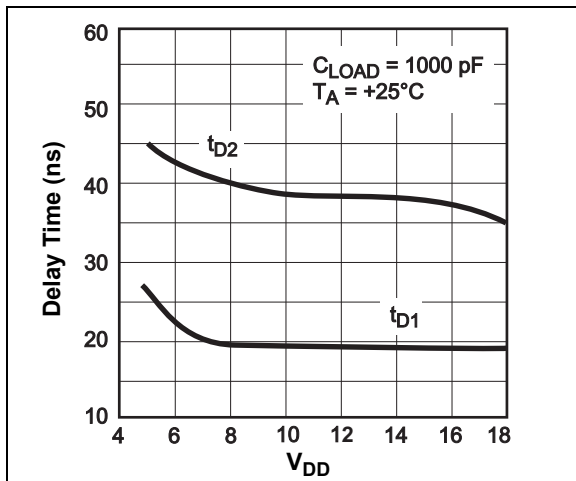


FIGURE 2-6: Propagation Delay vs. Supply Voltage.

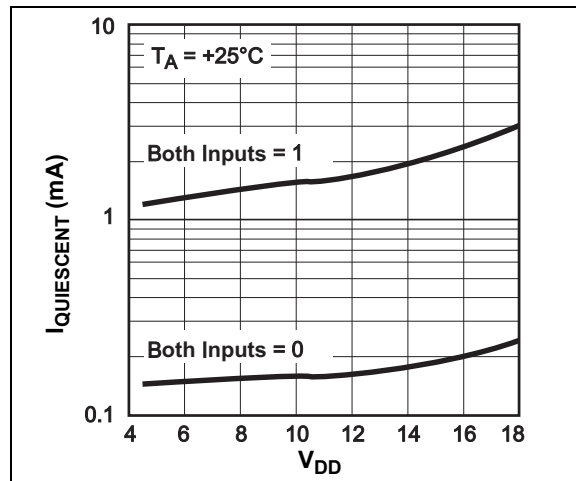


FIGURE 2-9: Quiescent Supply Current vs. Voltage.

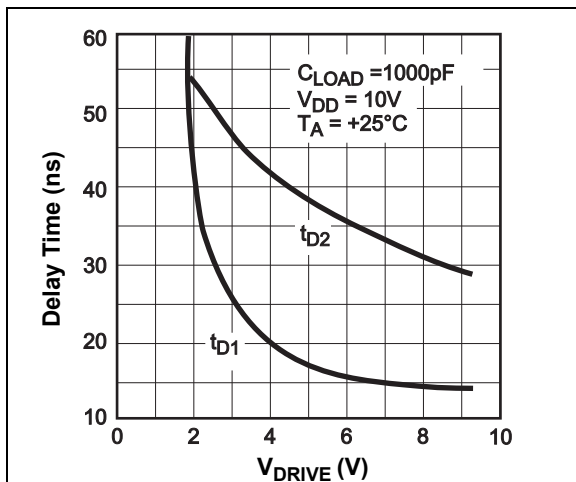


FIGURE 2-7: Effect of Input Amplitude on Delay Time.

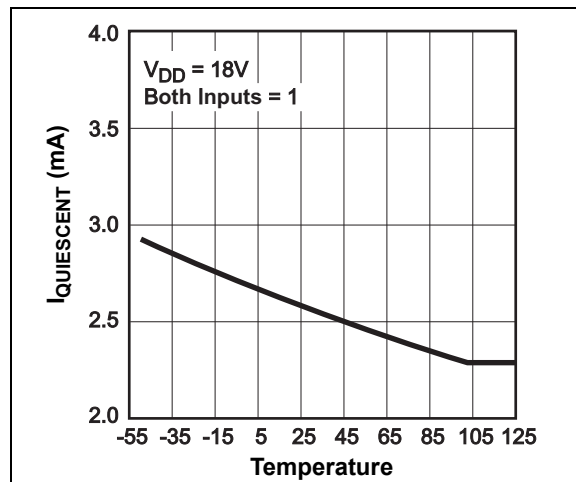


FIGURE 2-10: Quiescent Supply Current vs. Temperature.

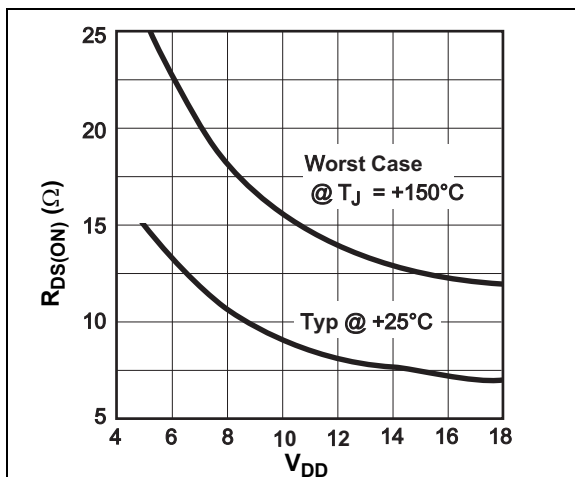


FIGURE 2-11: Pull-Up Output Resistance.

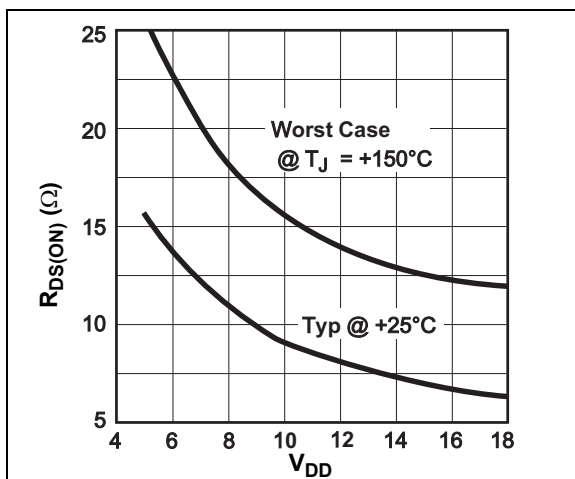


FIGURE 2-12: Pull-Down Output Resistance.

TC4404/TC4405

3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in [Table 3-1](#).

TABLE 3-1: PIN FUNCTION TABLE

| 8-Lead PDIP/SOIC | Symbol | Description |
|------------------|-----------------|--|
| 1 | V _{DD} | Supply Input, 4.5V to 18V |
| 2 | IN A | Control Input A, TTL/CMOS compatible input |
| 3 | IN B | Control Input B, TTL/CMOS compatible input |
| 4 | GND | Ground |
| 5 | B BOTTOM | Output B, pull-down |
| 6 | B TOP | Output B, pull-up |
| 7 | A BOTTOM | Output A, pull-down |
| 8 | A TOP | Output A, pull-up |

4.0 APPLICATIONS INFORMATION

4.1 Circuit Layout Guidelines

Long power supply and ground traces should be avoided as the added inductance causes unwanted voltage transients. Power and ground planes should be used wherever possible.

In addition, it is advisable that low ESR (Equivalent Series Resistance) bypass capacitors (4.7 μF or 10 μF tantalum) be placed as close to the driver as possible. In order to minimize the length of the output trace, the driver should be physically located as close as possible to the device it is driving.

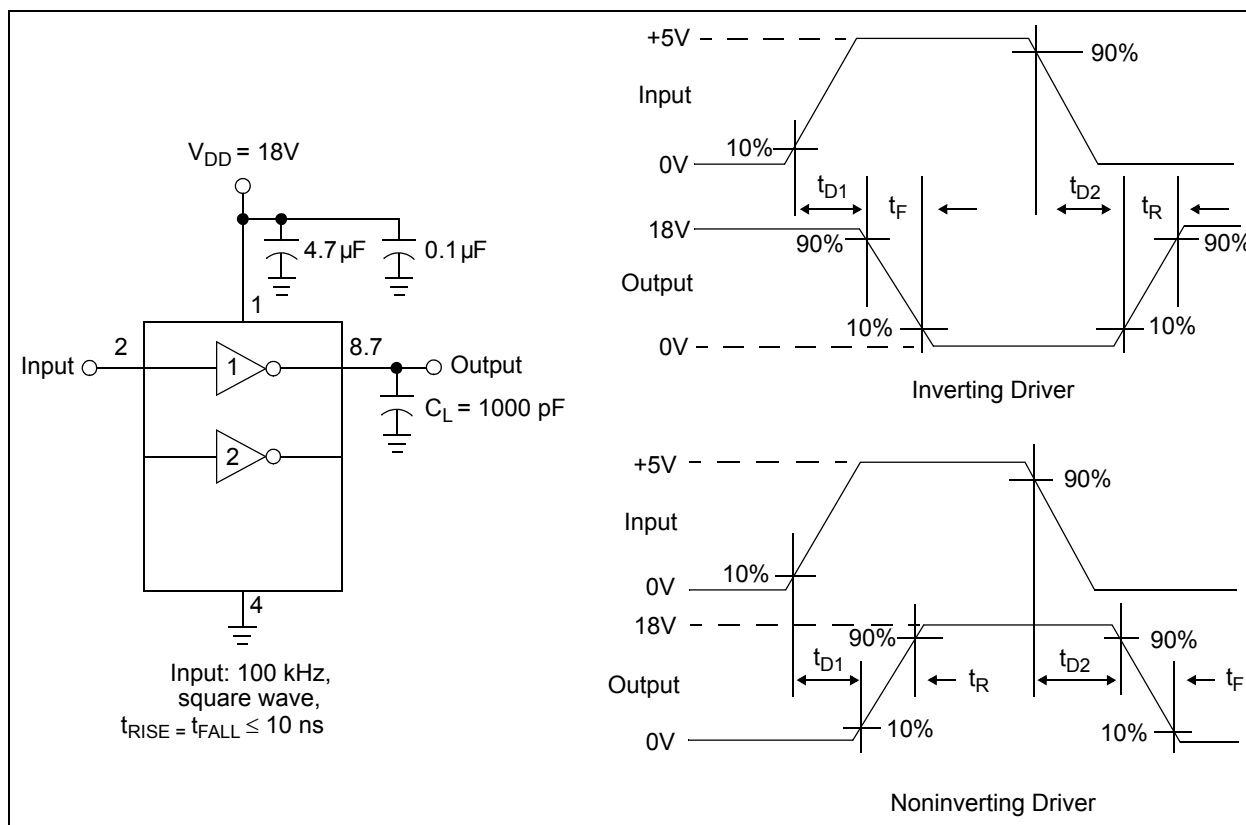


FIGURE 4-1: Switching Time Test Circuit.

4.2 Typical Applications

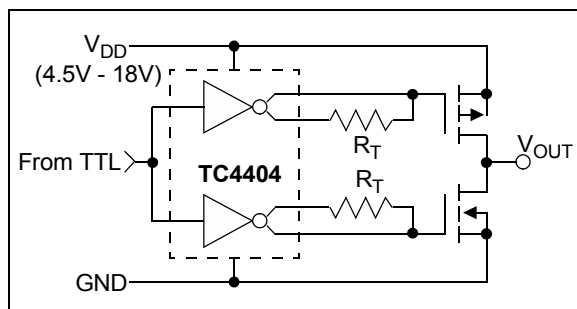


FIGURE 4-2: Zero Crossover Current Totem-Pole Switch.

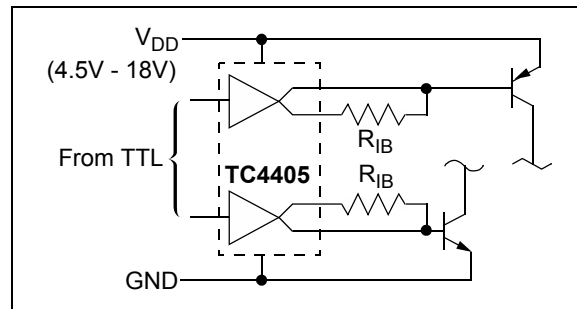


FIGURE 4-3: Driving Bipolar Transistors.

TC4404/TC4405

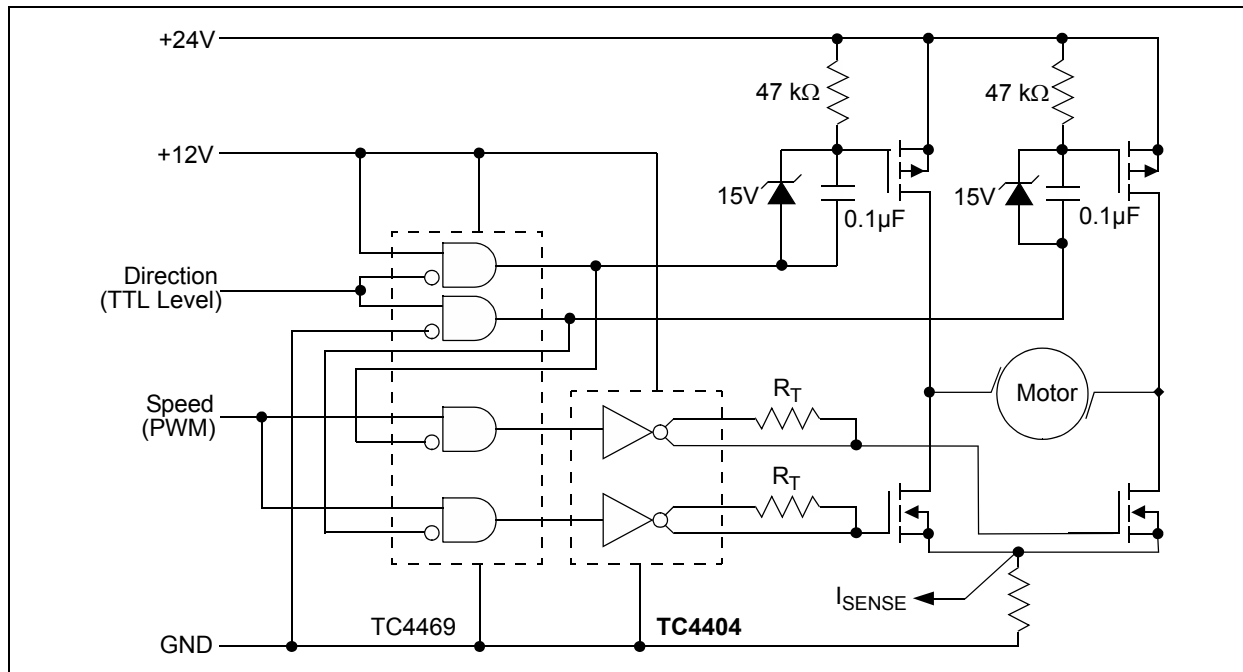


FIGURE 4-4: Servo Motor Control.

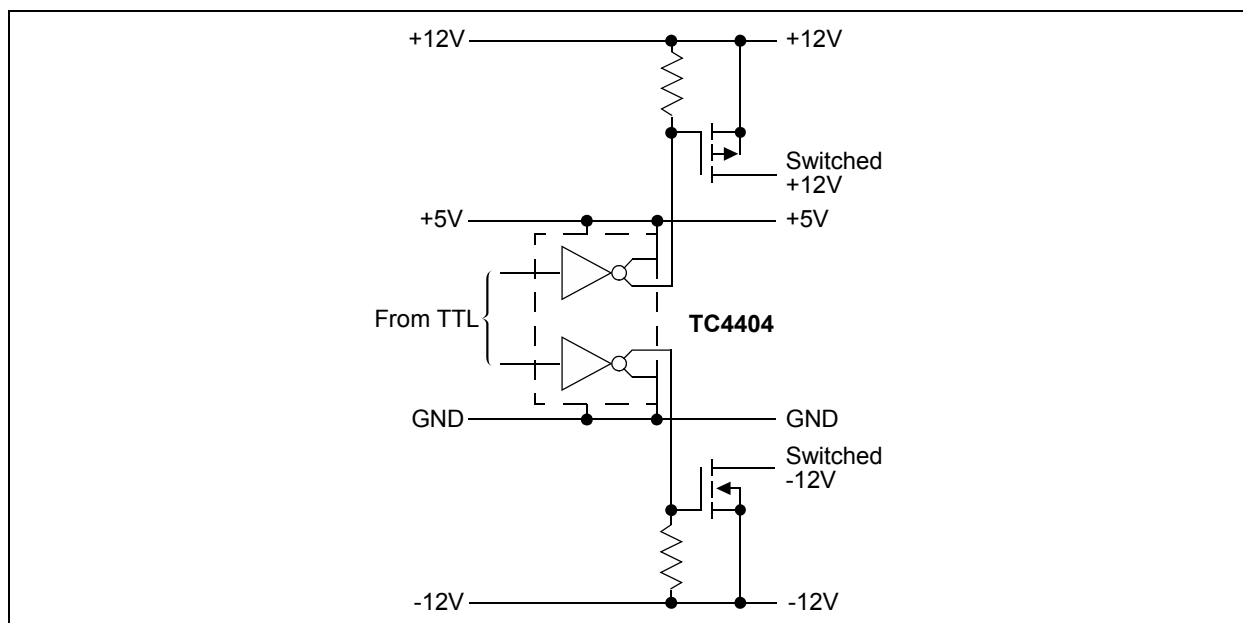
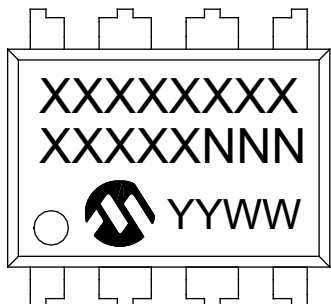


FIGURE 4-5: Reach-Up and Reach-Down Driving.

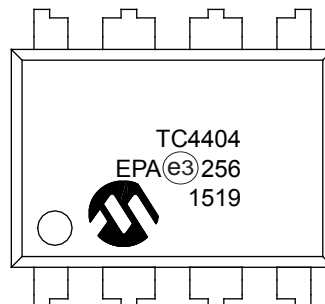
5.0 PACKAGING INFORMATION

5.1 Package Marking Information

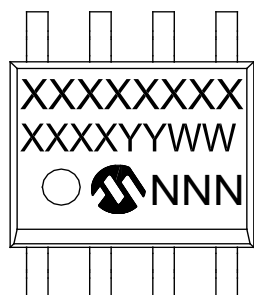
8-Lead PDIP (300 mil)



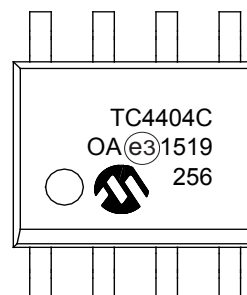
Example



8-Lead SOIC (3.90 mm)



Example



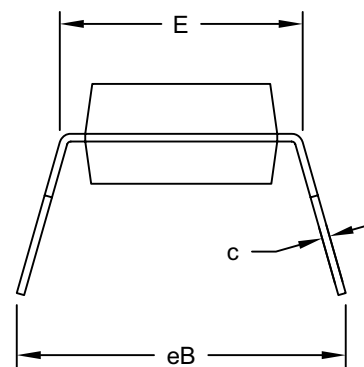
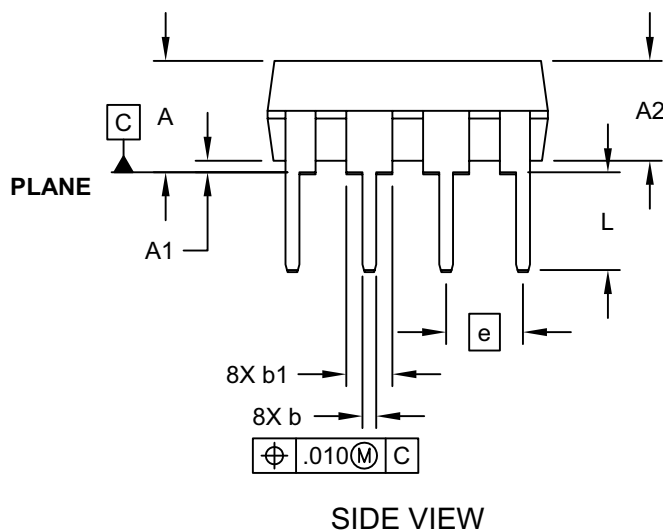
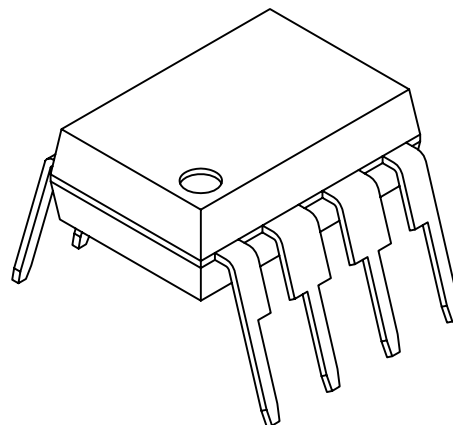
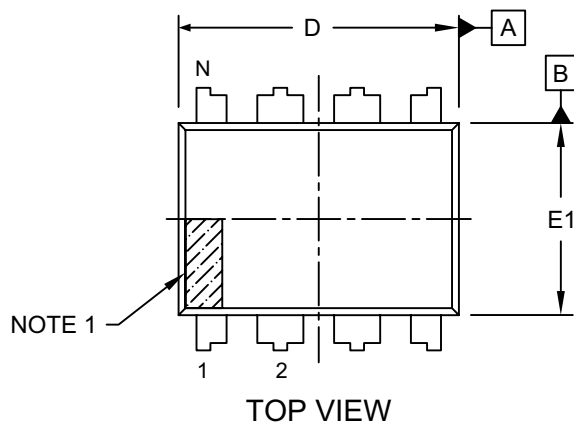
| | | |
|----------------|--------|--|
| Legend: | XX...X | Customer-specific information |
| | Y | Year code (last digit of calendar year) |
| | YY | Year code (last 2 digits of calendar year) |
| | WW | Week code (week of January 1 is week '01') |
| | NNN | Alphanumeric traceability code |
| | (e3) | Pb-free JEDEC designator for Matte Tin (Sn) |
| | * | This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package. |

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

TC4404/TC4405

8-Lead Plastic Dual In-Line (PA) - 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>

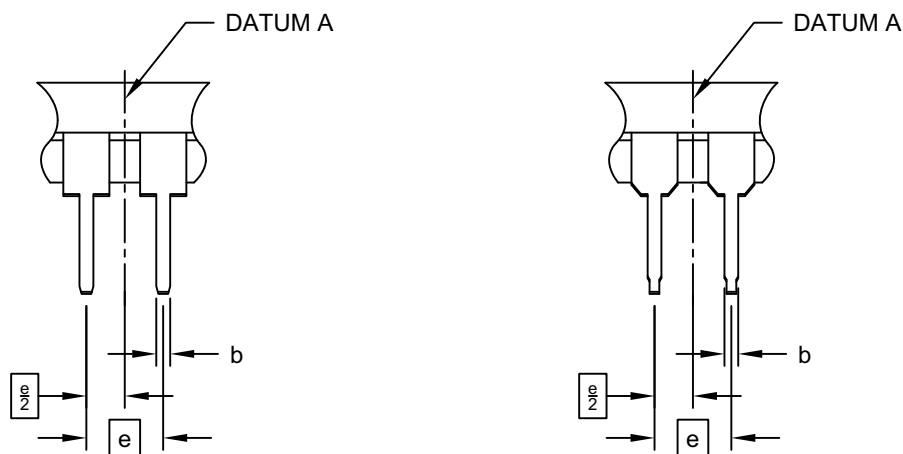


Microchip Technology Drawing No. C04-018D Sheet 1 of 2

8-Lead Plastic Dual In-Line (PA) - 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>

ALTERNATE LEAD DESIGN (VENDOR DEPENDENT)



| | | Units | INCHES | | |
|----------------------------|----|-------|----------|------|------|
| Dimension Limits | | | MIN | NOM | MAX |
| Number of Pins | N | | 8 | | |
| Pitch | e | | .100 BSC | | |
| Top to Seating Plane | A | | - | - | .210 |
| Molded Package Thickness | A2 | | .115 | .130 | .195 |
| Base to Seating Plane | A1 | | .015 | - | - |
| Shoulder to Shoulder Width | E | | .290 | .310 | .325 |
| Molded Package Width | E1 | | .240 | .250 | .280 |
| Overall Length | D | | .348 | .365 | .400 |
| Tip to Seating Plane | L | | .115 | .130 | .150 |
| Lead Thickness | c | | .008 | .010 | .015 |
| Upper Lead Width | b1 | | .040 | .060 | .070 |
| Lower Lead Width | b | | .014 | .018 | .022 |
| Overall Row Spacing | § | eB | - | - | .430 |

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- Dimensioning and tolerancing per ASME Y14.5M

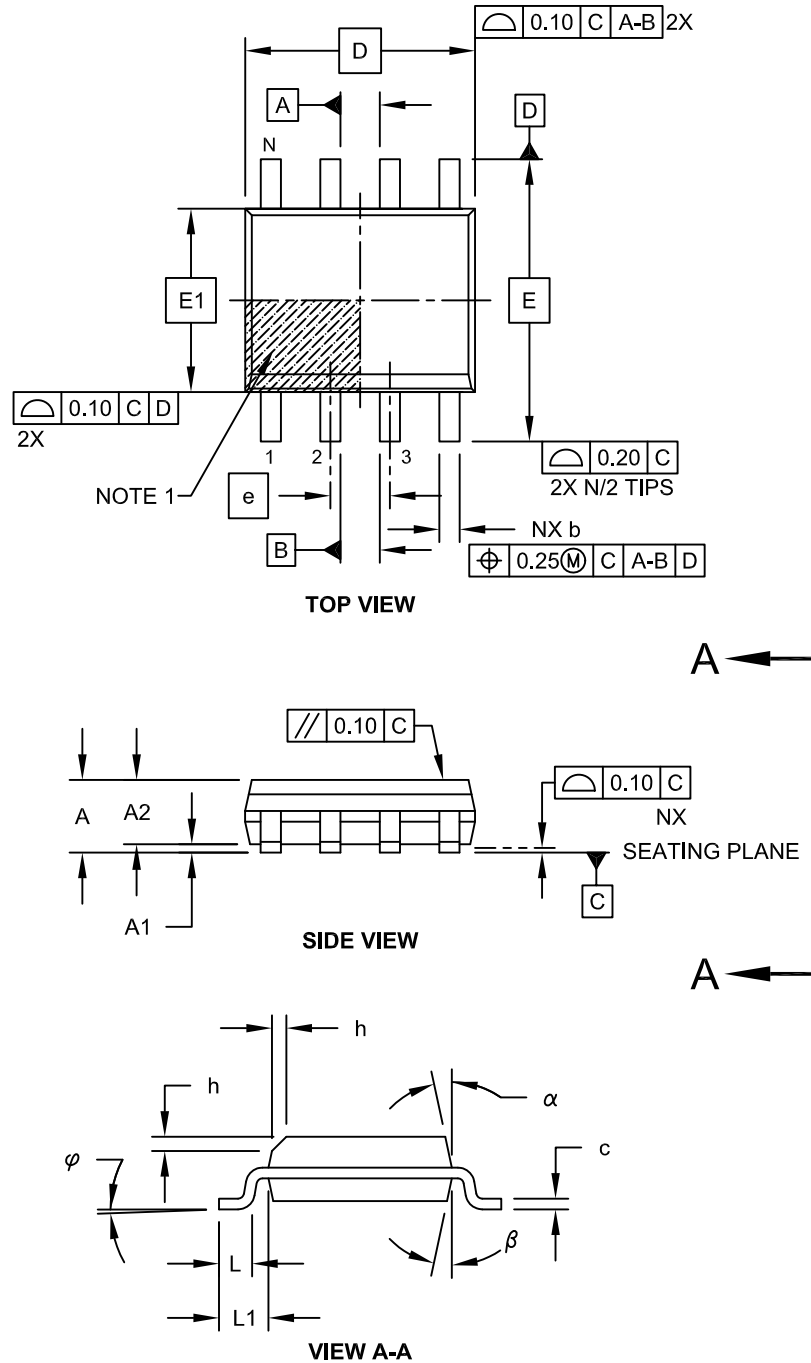
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-018D Sheet 2 of 2

TC4404/TC4405

8-Lead Plastic Small Outline (OA) - Narrow, 3.90 mm Body [SOIC]

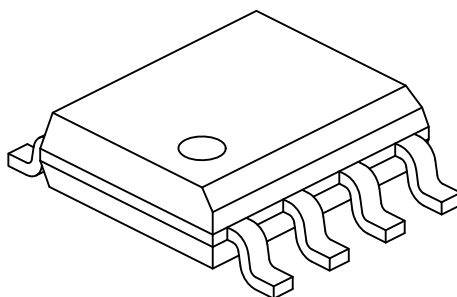
Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing No. C04-057C Sheet 1 of 2

8-Lead Plastic Small Outline (OA) - Narrow, 3.90 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits | Units | MILLIMETERS | | |
|--------------------------|-------|-------------|-----|------|
| | | MIN | NOM | MAX |
| Number of Pins | N | 8 | | |
| Pitch | e | 1.27 BSC | | |
| Overall Height | A | - | - | 1.75 |
| Molded Package Thickness | A2 | 1.25 | - | - |
| Standoff § | A1 | 0.10 | - | 0.25 |
| Overall Width | E | 6.00 BSC | | |
| Molded Package Width | E1 | 3.90 BSC | | |
| Overall Length | D | 4.90 BSC | | |
| Chamfer (Optional) | h | 0.25 | - | 0.50 |
| Foot Length | L | 0.40 | - | 1.27 |
| Footprint | L1 | 1.04 REF | | |
| Foot Angle | φ | 0° | - | 8° |
| Lead Thickness | c | 0.17 | - | 0.25 |
| Lead Width | b | 0.31 | - | 0.51 |
| Mold Draft Angle Top | α | 5° | - | 15° |
| Mold Draft Angle Bottom | β | 5° | - | 15° |

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
- Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

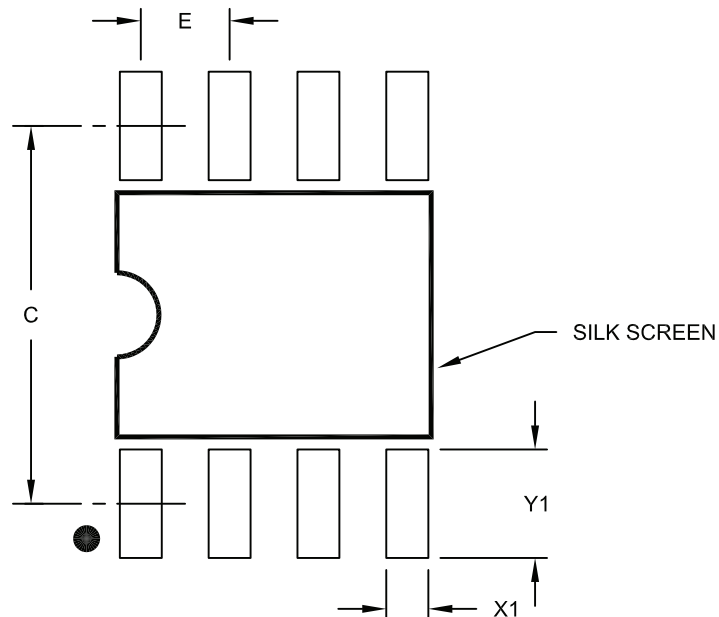
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-057C Sheet 2 of 2

TC4404/TC4405

8-Lead Plastic Small Outline (OA) – Narrow, 3.90 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|-------------------------|----|-------------|------|------|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | E | 1.27 BSC | | |
| Contact Pad Spacing | C | | 5.40 | |
| Contact Pad Width (X8) | X1 | | | 0.60 |
| Contact Pad Length (X8) | Y1 | | | 1.55 |

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2057A

APPENDIX A: REVISION HISTORY

Revision E (April 2016)

The following is the list of modifications:

1. Removed all information regarding the discontinued CERDIP package.
2. Added [Temperature Specifications](#) Table.
3. Added [Section 5.0, Packaging Information](#).
4. Added [Product Identification System](#) page.

Revision D (December 2012)

Added a note to each package outline drawing.

TC4404/TC4405

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

| <u>PART NO.</u> | | | <u>X</u> | | <u>XX</u> | |
|---------------------------|--|--|-------------------|---|---|--|
| Device | | | Temperature Range | | Package | |
| Device: | | | TC4404: | | Dual Open-Drain MOSFET Driver | |
| | | | TC4405: | | Dual Open-Drain MOSFET Driver | |
| Temperature Range: | | | C | = | 0°C to +70°C | |
| | | | E | = | -40°C to +85°C | |
| Package: | | | OA | = | Plastic Small Outline (3.90 mm Body),8-Lead, SOIC | |
| | | | PA | = | Plastic Dual In-Line (300 mil Body), 8-Lead, PDIP | |
| | | | OA713 | = | Plastic Small Outline (3.90 mm Body),8-Lead, SOIC (Tape and Reel) | |

Examples:

- a) TC4404COA: 1.5A Dual Open-Drain MOSFET Driver, 0°C to +70°C, 8LD SOIC Package
- b) TC4404EOA: 1.5A Dual Open-Drain MOSFET Driver, -40°C to +85°C, 8LD SOIC Package
- c) TC4404CPA: 1.5A Dual Open-Drain MOSFET Driver, 0°C to +70°C, 8LD PDIP Package
- d) TC4405EPA: 1.5A Dual Open-Drain MOSFET Driver, -40°C to +85°C, 8LD PDIP Package
- e) TC4404EOA713: 1.5A Dual Open-Drain MOSFET Driver, -40°C to +85°C, 8LD SOIC Package, Tape and Reel

TC4404/TC4405

NOTES:

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